Decrease in Hole Concentration in Al-doped 4H-SiC by Irradiation of 200 keV Electrons

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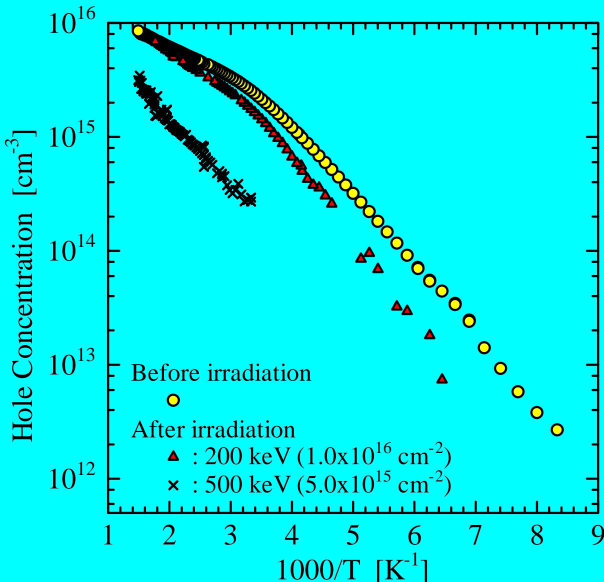
Abstract. From the temperature dependence of the hole concentration p(T) in lightly Al-doped 4H-SiC epilayer irradiated with several fluences of 200 keV electrons, the density (N_{Al}) of Al acceptors with E_V+0.2 eV decreases significantly with increasing fluence, whereas the density (N_{Defect}) of unknown acceptors (or defects) with E_V+0.37 eV increases with fluence at first and then decreases slightly. Although only C vacancies increases with fluence because 200 keV electrons can displace only C atoms, only the increase in the density of C monovacancies (V_C) located at midgap cannot explain the changes of p(T) by 200 keV electron irradiation. In order to explain the fluence dependences of N_{Al} and N_{Defect}, it may be necessary to consider the relationship between C vacancies and Al acceptors.

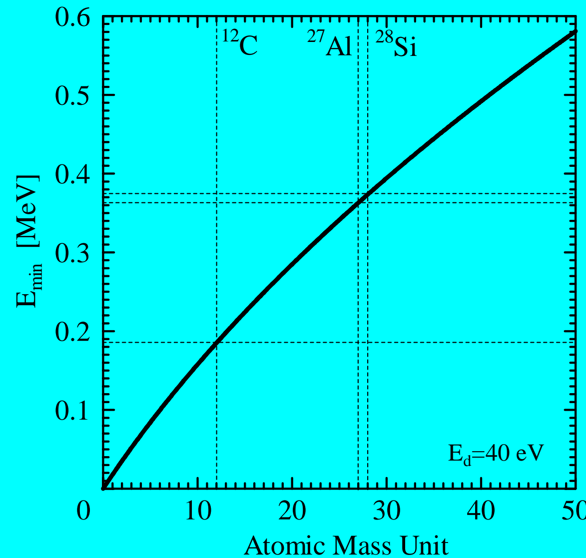
Introduction

Irradiation-energy dependence of p(T) (Refs. 1,2)



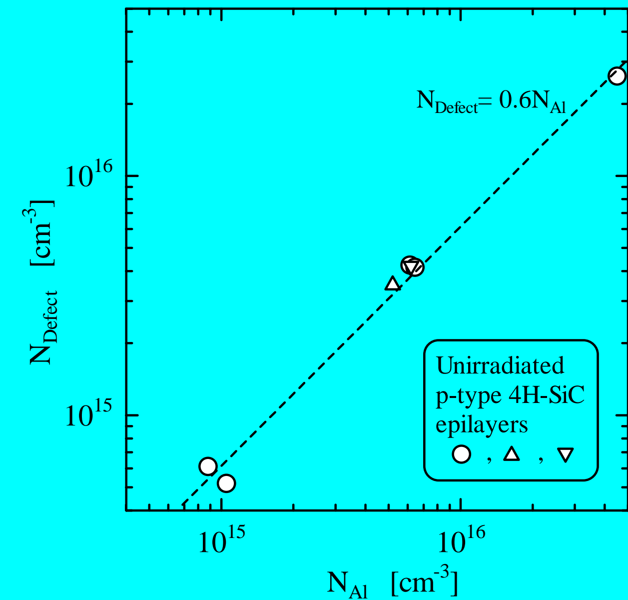
Although the fluence of 200 keV electrons is higher, the p(T) decreases less than due to 500 keV electron irradiation.

Atomic-mass-unit dependence of minimum electron energy required for displacement of substitutional atom in SiC (Ref. 1)



Energy		Displaced atoms
200 keV	→	only C atoms
500 keV	→	C, Al and Si atoms

Relationship between N_{Al} and N_{Defect} (Refs. 1,3)



$$N_{Defect} = 0.6 \times N_{Al}$$

↓

Unknown acceptors with E_V+0.37 eV are related to Al.

Experiment

Unirradiated Al-doped 4H-SiC epilayer

↓

Hall-effect measurement

↓

Irradiation of $1x10^{16}$ cm^{-2} fluence of 200 keV electrons

↓

Hall-effect measurement

↓

Irradiation of $2x10^{16}$ cm^{-2} fluence of 200 keV electrons

Hall-effect measurement

Total fluences
- **0 cm^{-2}**
- **$1x10^{16}$ cm^{-2}**
- **$3x10^{16}$ cm^{-2}**
- **$5x10^{16}$ cm^{-2}**
- **$7x10^{16}$ cm^{-2}**

Results

Fluence of 200 keV elecrons
: 0 cm^{-2}
: $1x10^{16}$ cm^{-2}
: $3x10^{16}$ cm^{-2}
: $5x10^{16}$ cm^{-2}
: $7x10^{16}$ cm^{-2}

Hole Concentration [cm^{-3}]
1000/T [K^{-1}]

Al-doped 4H-SiC epilayer
Experimental data
: 650 K
: 390 K
: 270 K

Hole Concentration [cm^{-3}]
Fluence of 200 keV electrons [$x10^{16}$ cm^{-2}]

: N_{Al}
: N_{Defect}

N_{Al} [$x10^{15}$ cm^{-3}]
N_{Defect} [$x10^{15}$ cm^{-3}]
Fluence of 200 keV Electrons [$x10^{16}$ cm^{-2}]

p(T) at low T decreases with fluence, whereas p(T) at high T seems unchanged.

N_{Al} decreases monotonously with increasing fluence, whereas N_{Defect} increases at first and then decreases.

Discussion

Under the assumption that only V_C is increased by 200 keV electron irradiation

Density of V_C
: 0 cm^{-3}
: $1x10^{15}$ cm^{-3}
: $3x10^{15}$ cm^{-3}
: $5x10^{15}$ cm^{-3}
: $7x10^{15}$ cm^{-3}

Hole Concentration [cm^{-3}]
1000/T [K^{-1}]

p(T) at all the T decreases with increasing V_C density.

Under the assumption that the unknown acceptor is a complex of Al and V_C

Al acceptor → **N_{Al} decreases, Al-V_C increases** → **Al-V_C decreases**

↓

N_{Al} decreases monotonously with fluence, whereas the density of Al-V_C increases at first with fluence and then decreases.

Summary

The unknown deep acceptors with E_V+0.37 eV may be related to Al and C vacancy.

References

1) Hideharu Matsuura, et al.: “Relationship between defects induced by irradiation and reduction of hole concentration in Al-doped 4H-SiC”, Physica B 376-377 (2006) 342-345.
2) Hideharu Matsuura, et al.: “Decrease in Al acceptor density in Al-doped 4H-SiC by irradiation with 4.6 electrons”, Appl. Phys. Lett. 83 (2003) 4981-4983.
3) Hideharu Matsuura, et al.: “Dependence of acceptor levels and hole mobility on acceptor density and temperature in Al-doped p-type 4H-SiC epilayers”, J. Appl. Phys. 96 (2004) 2708-2715.